

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A front end module for processing transmission signals and reception signals in each of a first frequency band and a second frequency band, the front end module comprising:

a first separating means for separating the first and second frequency bands from each other, where the first separating means is connected to an antenna and separating the first and second frequency bands from each other;

a second separating means for separating the transmission signals and the reception signals in the first frequency band from each other, where the second separating means is connected to the first separating means, including and includes a first pair of two acoustic wave elements each of which functions as a filter, ~~and separating the transmission signals and the reception signals in the first frequency band from each other;~~

a third separating means for separating the transmission signals and the reception signals in the second frequency band from each other, where the third separating means is connected to the first separating means, including and includes a second pair of two acoustic wave elements each of which functions as a filter, ~~and separating the transmission signals and the reception signals in the second frequency band from each other;~~ and

a single multi-layer substrate ~~for integrating~~ that integrates the first to third separating means, wherein

the first separating means is made up of a conductor layer located inside or on a surface of the multi-layer substrate.

2. (Currently Amended) The front end module according to claim 1, wherein:

~~the two first pair of~~ acoustic wave elements ~~that the second separating means includes~~ and the ~~two second pair of~~ acoustic wave elements ~~that the third separating means includes~~ are mounted on the multi-layer substrate; and

at least ~~part a~~ part of circuit portions of the second and third separating means except ~~the for the pairs of~~ acoustic wave elements is made up of the conductor layer located inside or on the surface of the multi-layer substrate.

3. (Currently Amended) The front end module according to claim 1, wherein the first separating means ~~incorporates~~ comprises:

a ~~filter for allowing first~~ filter that allows signals of frequencies in the first frequency band to pass through ~~this the first~~ filter and ~~intercepting intercepts~~ signals of frequencies in the second frequency band; and

a ~~filter for allowing second~~ filter that allows signals of frequencies in the second frequency band to pass through ~~this the second~~ filter and ~~intercepting intercepts~~ signals of frequencies in the first frequency band.

4. (Original) The front end module according to claim 1, wherein the transmission signals and the reception signals in each of the first and second frequency bands are signals of a code division multiple access system.

5. (New) The front end module according to claim 1, wherein:

the first separating means includes a filter;

one of the second and third separating means includes a delay line for impedance adjustment that is provided between one of the acoustic wave elements and the first separating means;

the first pair of two acoustic wave elements and the second pair of two acoustic wave elements are mounted on a top surface of the multi-layer substrate; and

the multi-layer substrate includes, as conductor layers located inside the multi-layer substrate, a ground layer, a conductor layer that forms the delay line and that is disposed between the ground layer and the top surface of the multi-layer substrate; and a conductor layer that forms the filter included in the first separating means and that is disposed between the ground layer and a bottom surface of the multi-layer substrate,

the front end module further comprising a terminal disposed on the bottom surface of the multi-layer substrate and connected to the conductor layer that forms the filter included in the first separating means.

6. (New) The front end module according to claim 5, further comprising a matching circuit provided between the delay line and the first separating means, wherein the multi-layer substrate further includes, as another conductor layer located inside the multi-layer substrate, a conductor layer that forms the matching circuit and that is disposed between the ground layer and the top surface of the multi-layer substrate.